



Product Change Notification

Change Notification #: **116014 - 01**
Change Title: **Intel® Server System R2312WTTYSR, Intel® Server System R2208WT2YSR, ~~Intel® Server System R2208WTTYC1R~~, Intel® Server System R2208WTTYSR, Intel® Server System R2224WTTYSR, Intel® Server System R2308WTTYSR PCN 116014-01, Product Design, 1100W Power supply Firmware update and internal wire change**
Reason for Revision: Remove product R2208WTTYC1R
Date of Publication: **May 04, 2018**

Key Characteristics of the Change:

Product Design

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material: *	Jan 04, 2018
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* Intel appreciates the customer's desire to receive the latest revision of products. However, Intel manages inventory on a first in first out (FIFO) basis at the MM# level. Subsequently, customer requests for a specific revision of material (below the MM#) will not be supported by Intel.

Description of Change to the Customer:

Reason for Revision: Remove product R2208WTTYC1

Intel is implementing the following changes on the Intel® Server System products listed in the table below.

1. Fix the Field Replaceable Unit (FRU) information that is embedded in the Intel 1100W Power Supply FW.
2. Replace an internal wire of the Intel 1100W Power Supply.
3. The Top Assembly (TA) number of the systems is rolling up.
4. The product code of the 1100W PSU is changing from G84027-007 G84027-008.

Customer Impact of Change and Recommended Action:

Intel does not expect any impact to customers from these changes, but encourages customers to understand the change and determine the impact on their applications. For that reason Intel recommends that the customer perform a standard level of evaluation. Customers can download and evaluate the latest BIOS/ME/Integrated BMC and FRUSDR release notes for more information at <http://www.intel.com/support>.

Products Affected / Intel Ordering Codes:

Product Code	MM#	Pre Change TA	Post Change TA
R2208WTTYSR	943826	J11484-009	J11484-010
R2208WT2YSR	943827	J11485-008	J11485-009
R2208WTTYC1R	943828	J11487-008	J11487-009
R2308WTTYSR	943829	J11493-009	J11493-010
R2224WTTYSR	943831	J11492-009	J11492-010
R2312WTTYSR	951229	J11495-010	J11495-011

PCN Revision History:

Date of Revision:

January 4, 2018

[May 4, 2018](#)

Revision Number:

00

[01](#)

Reason:

Originally Published PCN

[Remove product R2208WTTYC1R](#)



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The products described in this document may contain design defects or errors known as errata which may cause the product to deviate from published specifications. Current characterized errata are available on request.

Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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